

# Freescale Semiconductor Addendum

Document Number: MPC866UMAD

Rev. 2.2, 06/2010

# Errata to the MPC866 PowerQUICC User's Manual, Rev. 2

This errata describes corrections the MPC866 PowerQUICC User's Manual, Revision 2. For convenience, the section number and page number of the errata item in the reference manual are provided. Items in bold are new since the last revision of this document.

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# Changes

# Section/Page

# Changes

14.2.1/14-4

In Table 14-1, "The Input Frequency Requirements," change "320 MHz" to "400 MHz" as follows:

**Table 14-1. The Input Frequency Requirements** 

MODCK[1-2]	Frequency In	PDF	MFI, MFN, MFD for DPGDCK
00, 01	OSCM = 10 MHz to 10.66 MHz	0	160 MHz < OSCLK * 2 * (MFI + (MFN/ (MFD+1))) < 400 MHz
11	EXTCLK = 10 MHz to 10.66 MHz	0	160 MHz < OSCLK * 2 * (MFI + (MFN/ (MFD+1))) < 400 MHz
10	45 MHz ≤ EXTCLK ≤ 66 MHz	10 MHz ≤ EXTCLK/ (PDF+1) ≤ 32 MHz	160 MHz < OSCLK * 2 * (MFI + (MFN/ (MFD+1))) / (PDF+1) < 400 MHz

21.2.4, 20-10	In Table 20-4, "TODR Field Descriptions," in TOD field description, change "TOD is cleared automatically after one serial clock" to say "TOD is cleared automatically after 1 system clock"
21.3, 21-11	Under third bullet point, change "For an RxBD, the value must be even," to say, "For an RxBD, the value must be mod 4 aligned."
32.8/32-19	Add a note to beginning of section, as follows: "PIP in transparent mode is not supported."
H.1.1/H-4	Change the eleventh bulleted feature from "24 general purpose I/O port pins" to "26 general purpose I/O port pins."
H.2/H-5	Change the note to read:
	<b>Note:</b> All PCMCIA Slot B registers are reserved except for PGCRB, which is used to provide OP2 and OP3 functionality.

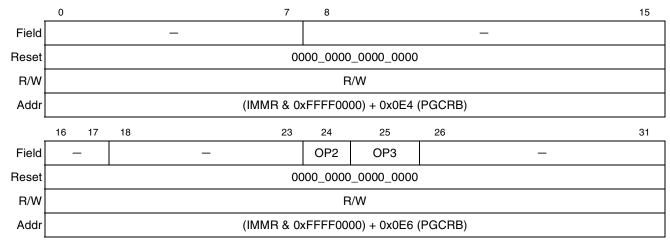


Figure H-2. PGCRB Register

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# Table H-1. PGCRB Field Descriptions

Bits	Name	Description
0–7	_	Reserved, should be cleared.
8–15	_	Reserved, should be cleared.
16–17	_	Reserved, should be cleared.
18–23	_	Reserved, should be cleared.
24	OP2	Writing a zero or a 1 is reflected on the pin.
25	OP3	Writing a zero or a 1 is reflected on the pin.
26–31	_	Reserved, should be cleared.

H.5/H-7

In Table H-2 (formerly Table H-1), delete second from last row "OP2/MODCK1/STS - OP2 removed".

Change last row "OP3/MODCK2/DSDO - OP3 removed and DSDO removed." to "OP3/MODCK2/DSDO - DSDO removed."



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